PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Alaa El-Agha	07/02/2010
Dustin Griesdorf	07/05/2010
Gareth P. Weale	07/05/2010
Jakob Nielson	07/05/2010

RECEIVING PARTY DATA

Name:	Semiconductor Components Industries, L.L.C.
Street Address:	5005 E. McDowell Rd.
Internal Address:	A700
City:	Phoenix
State/Country:	ARIZONA
Postal Code:	85008

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12027692

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: AMI07-113

NAME OF SUBMITTER: Becky Newnam

PATENT

REEL: 024636 FRAME: 0696

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Total Attachments: 2

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PATENT REEL: 024636 FRAME: 0697

Assignment and Agreement

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

Name of (City/State/Country)

Alaa El-Agha WATERLOO, ONTARIO, CANADA
Dustin Griesdorf WATERLOO, ONTARIO, CANADA
Gareth P. Weale NEW HAMBURG, ONTARIO, CANADA
Jakob Nielsen WATERLOO, ONTARIO, CANADA

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in

MULTI-FORMAT ALL-DIGITAL MODULATOR AND METHOD

Attorney Docket No. AMI07-113

described, illustrated, and claimed in an International application for Letters Patent of the Patent of the United States of America filed on 2/7/2008 as Application No. 12/027692 together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

We covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

PATENT REEL: 024636 FRAME: 0698

Assignment and Agreement Alaa El-Agha Witnessed by:

Printed Name: 55.5/4/6 Date: <u>July</u> 2,2010 Dustin Griesdorf

Gareth P. Weale

Witnessed by: 1

Witnessed by: Printed Name:

Date: 1424 9, 2010

Jakob Nielsen
Witnessed by: Ala Cagla

Printed Name: _____

Date: 545 7010

REEL: 024636 FRAME: 0699